

#### 1.6X0.8mm SMD CHIP LED LAMP

Part Number: KP-1608SECK-J3 Hyper Red

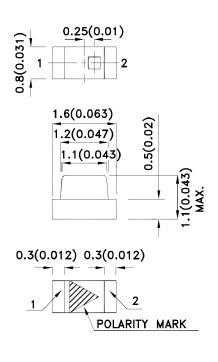
#### **Features**

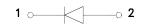
- 1.6mmX0.8mm SMT LED, 1.1mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

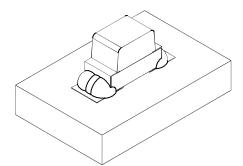
### Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

### **Package Dimensions**







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- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
  4.The device has a single mounting surface. The device must be mounted according to the specifications.

CHECKED: Allen Liu

DRAWN: Q.M.Chen



SPEC NO: DSAM9227 **REV NO: V.1A DATE: MAR/20/2013** PAGE: 1 OF 5

#### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
KD 40000EOK 12	Hyper Red (AlGaInP)	Matan Class	700	1100	120°
KP-1608SECK-J3		Water Clear	*200	*350	

#### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.2	2.8	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	V <sub>R</sub> =5V

- Notes: 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
  3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

### Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red		
Power dissipation	84	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

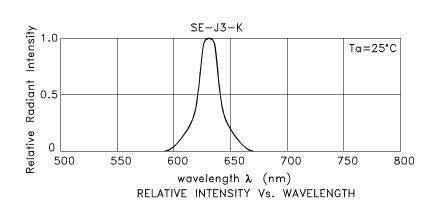
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAM9227 **REV NO: V.1A DATE: MAR/20/2013** PAGE: 2 OF 5

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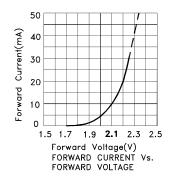
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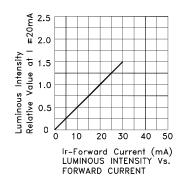
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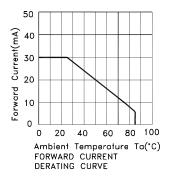


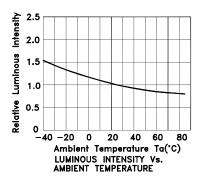
Hyper Red

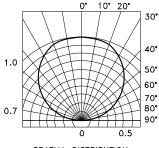
**KP-1608SECK-J3** 











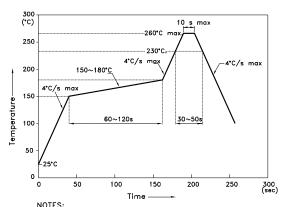
SPATIAL DISTRIBUTION

SPEC NO: DSAM9227 REV NO: V.1A DATE: MAR/20/2013 PAGE: 3 OF 5
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen

#### **KP-1608SECK-J3**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



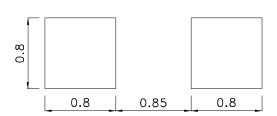
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

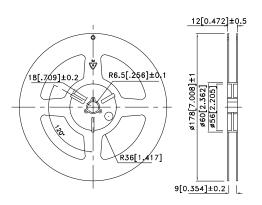
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

  3.Number of reflow process shall be 2 times or less.

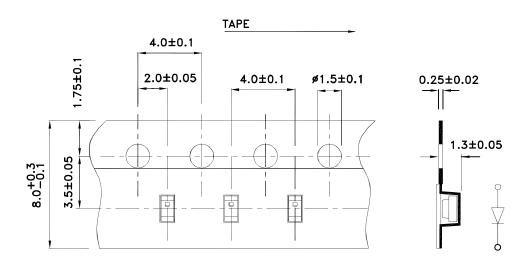
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**



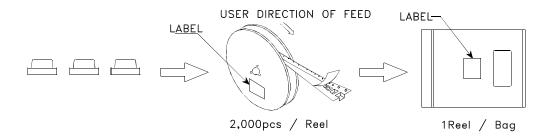
Tape Dimensions (Units : mm)

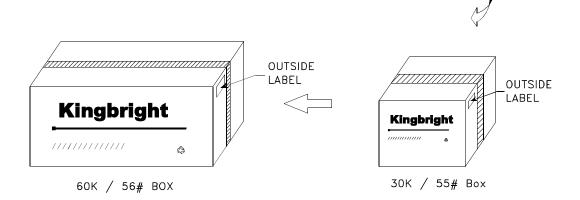


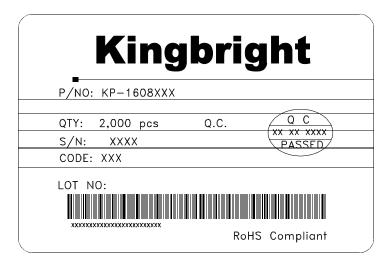
SPEC NO: DSAM9227 APPROVED: WYNEC REV NO: V.1A CHECKED: Allen Liu DATE: MAR/20/2013 DRAWN: Q.M.Chen PAGE: 4 OF 5

**PACKING & LABEL SPECIFICATIONS** 

#### **KP-1608SECK-J3**







Detailed application notes are listed on our website. <a href="http://www.kingbright.com/application">http://www.kingbright.com/application</a> notes

SPEC NO: DSAM9227 APPROVED: WYNEC REV NO: V.1A CHECKED: Allen Liu

DATE: MAR/20/2013 DRAWN: Q.M.Chen PAGE: 5 OF 5